

# General Description

The MAX6501-MAX6504 low-cost, fully integrated temperature switches assert a logic signal when their die temperature crosses a factory-programmed threshold. Operating from a +2.7V to +5.5V supply, these devices feature two on-chip, temperature-dependent voltage references and a comparator. They are available with factory-trimmed temperature trip thresholds from -45°C to +115°C in 10°C increments, and are accurate to ±0.5°C (typ) or ±4°C (max). These devices require no external components and typically consume 30µA supply current. Hysteresis is pin-selectable at +2°C or +10°C.

The MAX6501/MAX6503 have an active-low, open-drain output intended to interface with a microprocessor (µP) reset input. The MAX6502/MAX6504 have an activehigh, push/pull output intended to directly drive fancontrol logic. The MAX6501/MAX6502 are offered with hot-temperature thresholds (+35°C to +115°C), asserting when the temperature is above the threshold. The MAX6503/MAX6504 are offered with cold-temperature thresholds (-45°C to +15°C), asserting when the temperature is below the threshold.

The MAX6501-MAX6504 are offered in eight standard temperature versions; contact the factory for pricing and availability of non-standard temperature versions. They are available in 5-pin SOT23-5 and 7-pin TO-220\*3 packages.

# Applications

μP Temperature Monitoring in High-Speed Computers

Temperature Control

Temperature Alarms

Fan Control

Pin Configurations appear at end of data sheet. Typical Operating Circuit appears at end of data sheet. **Features** 

- ♦ ±0.5°C (typical) Threshold Accuracy **Over Full Temperature Range**
- No External Components Required
- **♦ Low Cost**
- **♦ 30µA Supply Current**
- ♦ Factory-Programmed Thresholds from -45°C to +115°C in 10°C Increments
- ♦ Open-Drain Output (MAX6501/MAX6503) Push/Pull Output (MAX6502/MAX6504)
- ♦ Pin-Selectable +2°C or +10°C Hysteresis
- ♦ SOT23-5 Package

# **Ordering Information**

PART*	OPERATING TEMP. RANGE	PIN-PACKAGE
MAX6501UKT	-55°C to +125°C	5 SOT23-5
MAX6502UKT	-55°C to +125°C	5 SOT23-5
MAX6503UKT	-55°C to +125°C	5 SOT23-5
MAX6504UKT	-55°C to +125°C	5 SOT23-5

\*These parts are offered in eight standard temperature versions with a minimum order of 2,500 pieces. To complete the suffix information, add P or N for positive or negative trip temperature, and select an available trip point in degrees centigrade. For example, the MAX6501UKP065-T describes a MAX6501 in a SOT23-5 package with a +65°C threshold. Contact the factory for pricing and availability of non-standard temperature versions (minimum order 10,000 pieces).

## Selector Guide

	OUTPUT	CUITPUT TRIP			STANDARD TEMPERATURE THRESHOLDS (°C)						
PART	STAGE	TEMPERATURE THRESHOLD	-15	5	45	55	65	75	85	95	
MAX6501	Open-Drain	Hot			√	√	√	√	√	<b>√</b>	
MAX6502	Push/Pull	Hot			√	√	√	√	√	√	
MAX6503	Open-Drain	Cold	V	√							
MAX6504	Push/Pull	Cold	V	√							

†Patents Pending

<sup>\*\*</sup>Future package. Contact factory for availability.

### ABSOLUTE MAXIMUM RATINGS

Supply Voltage (VCC)       -0.3V to +7V         TOVER (MAX6501)       -0.3V to +7V         TOVER (MAX6502)       -0.3V to (VCC + 0.3V)         TUNDER (MAX6503)       -0.3V to +7V         TUNDER (MAX6504)       -0.3V to (VCC + 0.3V)         All Other Pins       -0.3V to (VCC + 0.3V)         Input Current (all pins)       20mA	Output Current (all pins)
--	---------------------------

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

(VCC = +2.7V to +5.5V, RPULL-UP = 100kΩ (MAX6501/MAX6503 only), TA = TMIN to TMAX, unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Supply Voltage Range	Vcc		2.7		5.5	V	
Supply Current	Icc			30	85	μΑ	
		-45°C to -25°C	-6	±0.5	6	°C	
Temperature Threshold	$\Delta T_{TH}$	-15°C to +15°C	-4	±0.5	4		
Accuracy (Note 2)	ΔΠΗ	+35°C to +65°C	-4 ±0.5 4	4			
		+75°C to +115°C	-6	±0.5	.5 6		
Temperature Threshold	Tuncor	HYST = GND		2		°C.	
Hysteresis	THYST	HYST = VCC		10			
HYST Input Threshold	VIH		0.8 x V <sub>CC</sub>		V		
(Note 3)	VIL			).2 x Vcc			
Output Voltage High	Vон	ISOURCE = 500μA, V <sub>CC</sub> > 2.7V (MAX6502/MAX6504 only)	0.8 x V <sub>CC</sub>			V	
Output Voltage High	VOH	ISOURCE = 800μA, V <sub>CC</sub> > 4.5V (MAX6502/MAX6504 only)	V <sub>CC</sub> - 1.5			V	
Output Voltage Lew	Vai	ISINK = 1.2mA, VCC > 2.7V			0.3	V	
Output Voltage Low	VoL	I <sub>SINK</sub> = 3.2mA, V <sub>CC</sub> > 4.5V			0.4	V	
Open-Drain Output Leakage Current		V <sub>CC</sub> = 2.7V, V <sub>TUNDER</sub> = 5.5V (MAX6503), V <sub>TOVER</sub> = 5.5V (MAX6501)		10		nA	

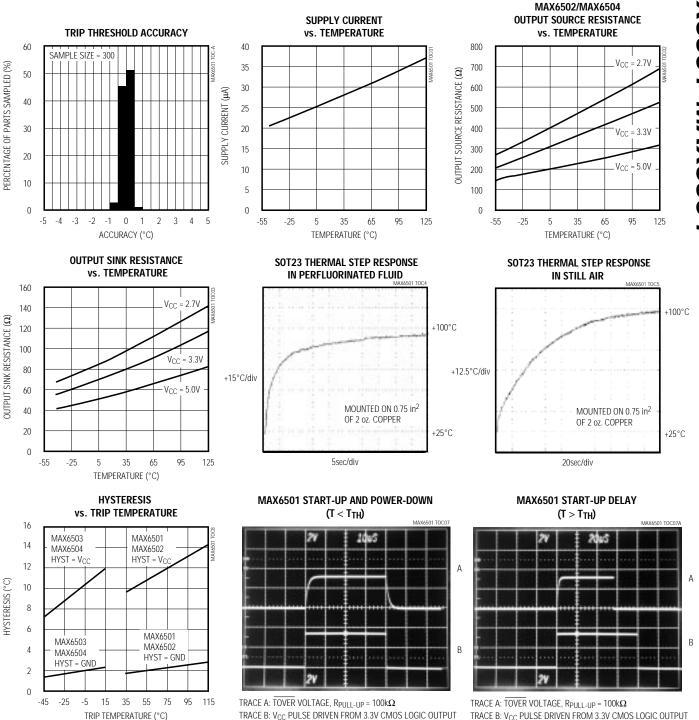
**Note 1:** 100% production tested at  $T_A = +25$ °C. Specifications over temperature limits are guaranteed by design.

Note 2: The MAX6501-MAX6504 are available with internal, factory-programmed temperature trip thresholds from -45°C to +115°C in +10°C increments (Table 2).

Note 3: Guaranteed by design.

# Typical Operating Characteristics

 $(V_{CC} = +5V, R_{PULL-UP} = 100k\Omega (MAX6501/MAX6503), T_A = +25^{\circ}C, unless otherwise noted.)$ 



# Pin Description

	Р	IN		NAME	FUNCTION
MAX6501	MAX6502	MAX6503	MAX6504	NAME	FUNCTION
1, 2	1, 2	1, 2	1, 2	GND	Ground. Not internally connected. Tie both ground pins together close to the chip. Pin 2 provides the lowest thermal resistance to the die.
3	3	3	3	HYST	Hysteresis Input. Connect HYST to GND for $+2^{\circ}$ C hysteresis, or connect to V <sub>CC</sub> for $+10^{\circ}$ C hysteresis.
4	4	4	4	Vcc	Supply Input (+2.7V to +5.5V)
5	_	_	_	TOVER	Open-Drain, Active-Low Output. $\overline{\text{TOVER}}$ goes low when the die temperature exceeds the factory-programmed temperature threshold. Connect to a 100k $\Omega$ pull-up resistor. May be pulled up to a voltage higher than $V_{CC}$ .
_	5	_	_	TOVER	Push/Pull Active-High Output. TOVER goes high when the die temperature exceeds the factory-programmed temperature threshold.
_	_	5	_	TUNDER	Open-Drain, Active-Low Output. TUNDER goes low when the die temperature goes below the factory-programmed temperature threshold. Connect to a 100k $\Omega$ pull-up resistor. May be pulled up to a voltage higher than $V_{CC}$ .
_	_	_	5	TUNDER	Push/Pull Active-High Output. TUNDER goes high when the die temperature is below the factory-programmed temperature threshold.

# **General Description**

The MAX6501–MAX6504 fully integrated temperature switches incorporate two temperature-dependent references and a comparator. One reference exhibits a positive temperature coefficient and the other a negative temperature coefficient. The temperature at which the two reference voltages are equal determines the temperature trip point. Pin-selectable +2°C or +10°C hysteresis keeps the output from oscillating when the die temperature is close to the threshold temperature. The MAX6501/MAX6503 have an active-low, open-drain output structure that can only sink current. The MAX6502/MAX6504 have an active-high, push/pull output structure that can sink or source current. The internal power-on reset circuit guarantees the output is at  $T_{TH} = +25$ °C state at start-up for 50µs.

The MAX6501-MAX6504 are available with factory-preset temperature thresholds from -45°C to +115°C in 10°C increments. Table 1 lists available temperature thresholds. The MAX6501/MAX6503 outputs are intended to interface with a microprocessor ( $\mu$ P) reset input (Figure 2). The MAX6502/MAX6504 outputs are intended for applications such as driving a fan control (Figure 3).

# Table 1. Factory-Programmed Threshold Range

PART NUMBER	THRESHOLD (T <sub>TH</sub> ) RANGE	
MAX6501	+35°C < T <sub>TH</sub> < +115°C	
MAX6502	+35°C < T <sub>TH</sub> < +115°C	
MAX6503	-45°C < T <sub>TH</sub> < +15°C	
MAX6504	-45°C < T <sub>TH</sub> < +15°C	

### Hysteresis Input

The HYST pin is a CMOS-compatible input that selects hysteresis at either a high level ( $\pm 10^{\circ}$ C for HYST = V<sub>CC</sub>) or a low level ( $\pm 2^{\circ}$ C for HYST = GND). Hysteresis prevents the output from oscillating when the temperature is near the trip point. The HYST pin should not float. Drive HYST close to ground or V<sub>CC</sub>. Other input voltages cause increased supply current. The actual amount of hysteresis depends on the part's programmed trip threshold. (See the *Typical Operating Characteristics*.)

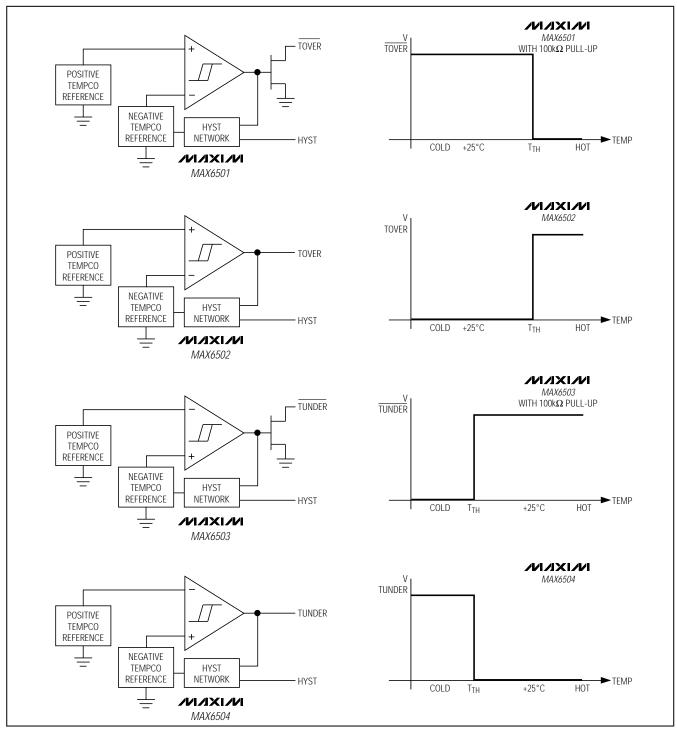


Figure 1. Block and Functional Diagrams

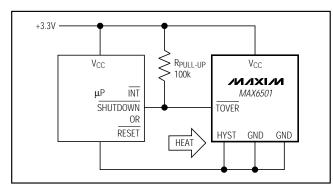


Figure 2. Microprocessor Alarm/Reset

# **Applications Information**

### Thermal Considerations

The MAX6501–MAX6504 supply current is typically  $30\mu A$ . When used to drive high-impedance loads, the devices dissipate negligible power. Therefore, the die temperature is essentially the same as the package temperature. The key to accurate temperature monitoring is good thermal contact between the MAX6501–MAX6504 package and the device being monitored. In some applications, the SOT23-5 package may be small enough to fit underneath a socketed  $\mu P$ , allowing the device to monitor the  $\mu P$ 's temperature directly. The TO-220 package can monitor the temperature of a heat sink directly, and presents the lower thermal resistance of the two packages. Use the monitor's output to reset the  $\mu P$ , assert an interrupt, or trigger an external alarm.

Accurate temperature monitoring depends on the thermal resistance between the device being monitored and the MAX6501–MAX6504 die. Heat flows in and out of plastic packages, primarily through the leads. Pin 2 of the SOT23-5 package provides the lowest thermal resistance to the die. Short, wide copper traces leading to the temperature monitor ensure that heat transfers quickly and reliably.

The rise in die temperature due to self-heating is given by the following formula:

### $\Delta T_{J} = PDISSIPATION X \theta_{JA}$

where PDISSIPATION is the power dissipated by the MAX6501-MAX6504, and  $\theta_{\text{JA}}$  is the package's thermal resistance.

The typical thermal resistance is 140°C/W for the SOT23-5 package and TBD°C/W for the TO-220 package. To limit the effects of self-heating, minimize the output currents. For example, if the MAX6501 or MAX6503 sink 1mA, the output voltage is guaranteed to be less than 0.3V. Therefore, an additional 0.3mW of

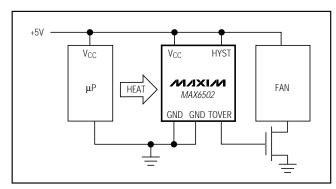


Figure 3. Overtemperature Fan Control

power is dissipated within the IC. This corresponds to a 0.042°C shift in the die temperature in the SOT23-5.

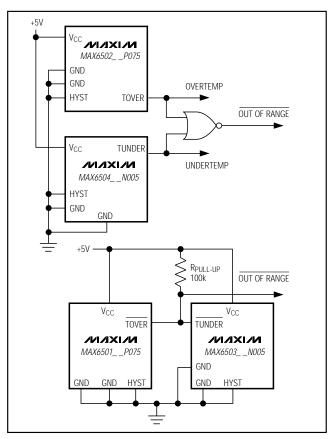
### **Temperature-Window Alarm**

The MAX6501–MAX6504 temperature switch outputs assert when the die temperature is outside the factory-programmed range. Combining the outputs of two devices creates an over/undertemperature alarm. The MAX6501/MAX6503 and the MAX6502/MAX6504 are designed to form two complementary pairs, each containing one cold trip point output and one hot trip point output. The assertion of either output alerts the system to an out-of-range temperature. The MAX6502/ MAX6504 push/pull output stages can be ORed to produce a thermal out-of-range alarm. More favorably, a MAX6501/MAX6503 can be directly wire-ORed with a single external resistor to accomplish the same task (Figure 4).

The temperature window alarms in Figure 4 can be used to accurately determine when a device's temperature falls out of the -5°C to +75°C range. The thermal-overrange signal can be used to assert a thermal shutdown, power-up, recalibration, or other temperature-dependent function.

# Low-Cost, Fail-Safe Temperature Monitor

In high-performance/high-reliability applications, multiple temperature monitoring is important. The high-level integration and low cost of the MAX6501–MAX6504 facilitate the use of multiple temperature monitors to increase system reliability. Figure 5's application uses two MAX6502s with different temperature thresholds to ensure that fault conditions that can overheat the monitored device cause no permanent damage. The first temperature monitor activates the fan when the die temperature exceeds +45°C. The second MAX6502 triggers a system shutdown if the die temperature reaches +75°C. The second temperature monitor's output asserts when a wide variety of destructive fault conditions occur, including latchups, short circuits, and cooling-system failures.



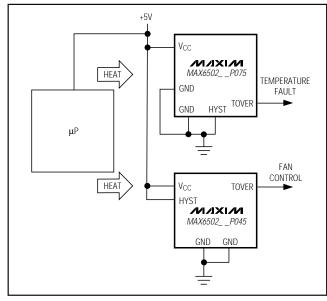


Figure 5. Low-Power, High-Reliability, Fail-Safe Temperature Monitor

Figure 4. Temperature-Window Alarms

Table 3. Device Marking Codes for SOT23-5 Package

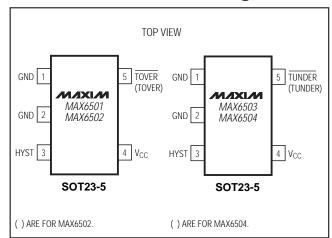
DEVICE	CODE	MINIMUM ORDER
MAX6501UKP035	ABZF	2.5k
MAX6501UKP045	ABZR	2.5k
MAX6501UKP055	ACAC	2.5k
MAX6501UKP065	ABZS	2.5k
MAX6501UKP075	ACAD	2.5k
MAX6501UKP085	ACAE	2.5k
MAX6501UKP095	ABZT	2.5k
MAX6501UKP105	ACAF	10k
MAX6501UKP115	ACAG	10k
MAX6502UKP035	ABZG	2.5k
MAX6502UKP045	ABZU	2.5k
MAX6502UKP055	ACAM	2.5k
MAX6502UKP065	ABZV	2.5k
MAX6502UKP075	ACAI	2.5k
MAX6502UKP085	ACAJ	2.5k
MAX6502UKP095	ABZW	2.5k

DEVICE	CODE	MINIMUM ORDER
MAX6502UKP105	ACAK	10k
MAX6502UKP115	ACAL	10k
MAX6503UKN045	ACAR	10k
MAX6503UKN035	ACAQ	10k
MAX6503UKN025	ACAP	10k
MAX6503UKN015	ACAO	2.5k
MAX6503UKN005	ACAN	10k
MAX6503UKP005	ABZX	2.5k
MAX6503UKP015	ACAM	10k
MAX6504UKN045	ACAX	10k
MAX6504UKN035	ACAW	10k
MAX6504UKN025	ACAV	10k
MAX6504UKN015	ACAU	2.5k
MAX6504UKN005	ACAT	10k
MAX6504UKP005	ABZY	2.5k
MAX6504UKP015	ACAS	10k

# Typical Operating Circuit

# +2.7V TO +5.5V Vcc Vcc MAXIM MAX6502 TOVER GND GND HYST GND GND GND GND GND HORE HORE

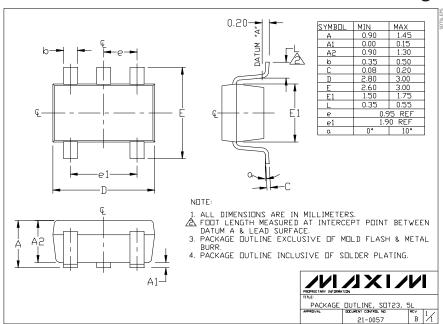
# Pin Configurations



# \_Typical Operating Circuit

TRANSISTOR COUNT: 237 SUBSTRATE CONNECTED TO GND

# Package Information



Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

8 \_\_\_\_\_\_Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600